

Product Summary

V _{BR} (Min)	I _{PP} (Max)	C _T (Typ)
25.4	3A	11pF

Features

- 200W Peak Power Dissipation per Line (8/20μs Waveform)
- Provides ESD Protection per IEC 61000-4-2 Standard:
Air ±30kV, Contact ±30kV
- 2 Channels of ESD Protection
- Low Channel Input Capacitance
- **Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**
- **The DESD1CAN2SOQ is suitable for automotive applications requiring specific change control; this part is AEC-Q101 qualified, PPAP capable, and manufactured in IATF 16949 certified facilities.**

<https://www.diodes.com/quality/product-definitions/>

Description and Applications

This DESD1CAN2SOQ is a next generation ESD and surge protection device packaged in a small footprint surface-mount package. It is qualified to AEC-Q101, supported by a PPAP and is designed to protect two data lines of the Controller Area Network (CAN) in an automotive.

- CAN bus protection
- Industrial control networks

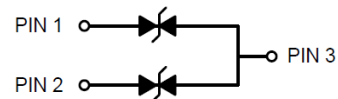
Mechanical Data

- Package: SOT23
- Package Material: Molded Plastic, "Green" Molding Compound.
UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish Annealed over Alloy 42 Leadframe (Lead Free Plating). Solderable per MIL-STD-202, Method 208@3
- Weight: 0.009 grams (Approximate)

SOT23



Bottom View



Device Schematic

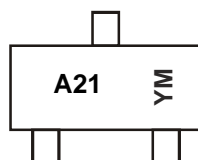
Ordering Information (Note 4)

Orderable Part Number	Package	Marking	Reel Size (inches)	Tape Width (mm)	Packing	
					Qty.	Carrier
DESD1CAN2SOQ-7	SOT23	A21	7	8	3,000	Tape & Reel

- Notes:
1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
 2. See <https://www.diodes.com/quality/lead-free/> for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
 4. For packaging details, go to our website at <https://www.diodes.com/design/support/packaging/diodes-packaging/>.

Marking Information

SOT23



A21 = Product Type Marking Code
 YM = Date Code Marking
 Y = Year (ex: M = 2025)
 M = Month (ex: 9 = September)

Date Code Key

Year	2014	-	2025	2026	2027	2028	2029	2030	2031	2032	2033	2034
Code	B	-	M	N	P	R	S	T	U	V	W	X

Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	O	N	D

Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	Conditions
Peak Pulse Power Dissipation	P _{PP}	200	W	8/20μs, per Figure 1
Peak Pulse Current	I _{PP}	3	A	8/20μs, per Figure 1
ESD Protection – Contact Discharge	V _{ESD_Contact}	±30	kV	IEC 61000-4-2 Standard
ESD Protection – Air Discharge	V _{ESD_Air}	±30	kV	IEC 61000-4-2 Standard

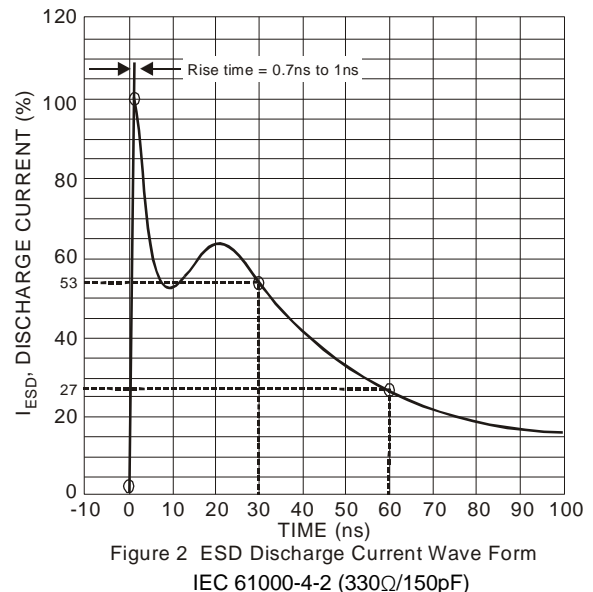
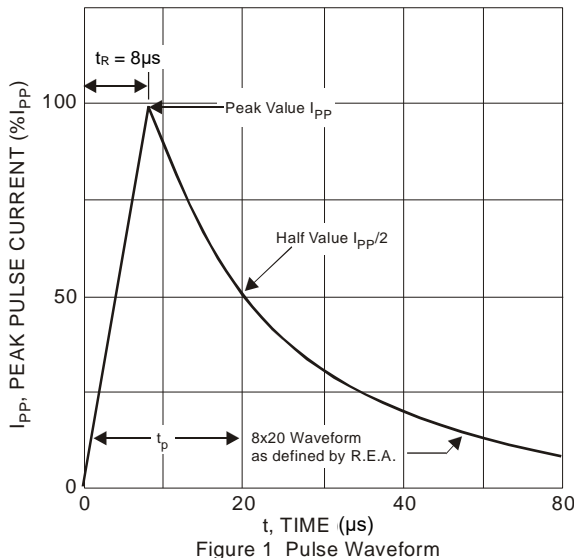
Thermal Characteristics

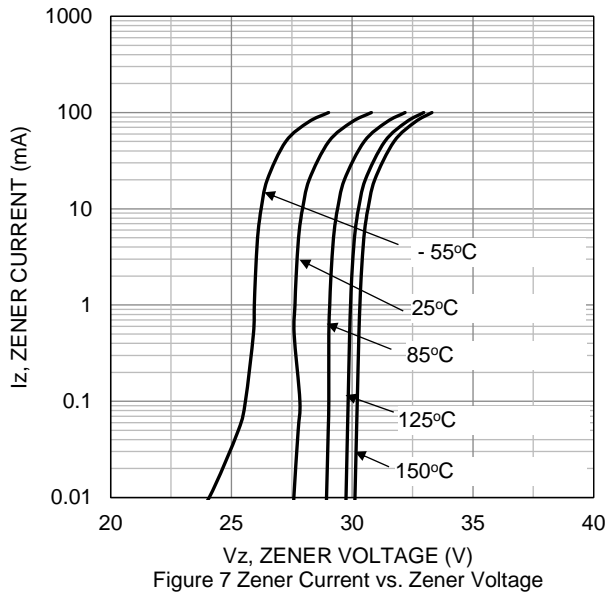
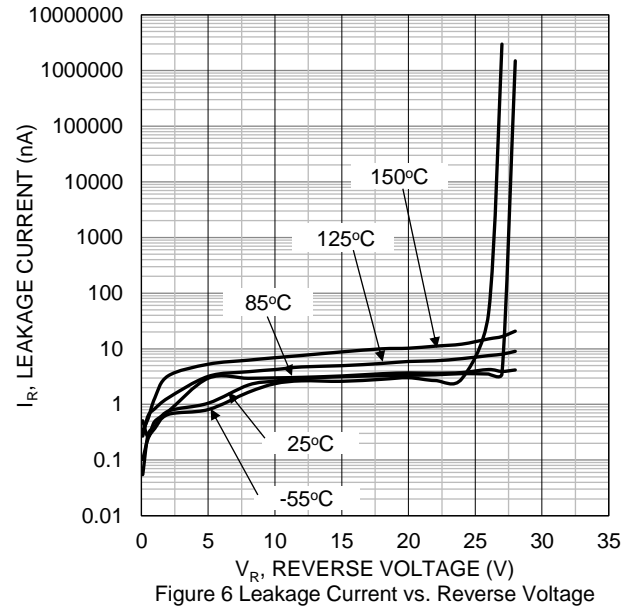
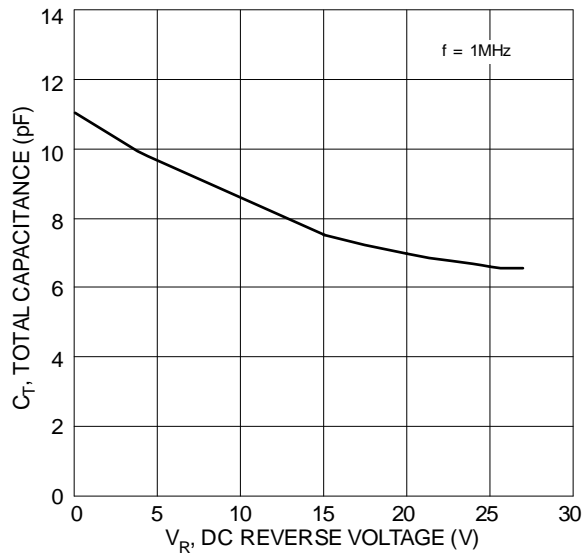
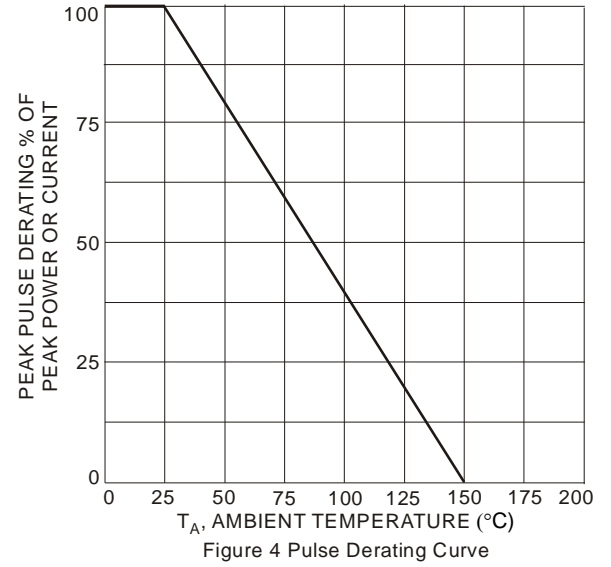
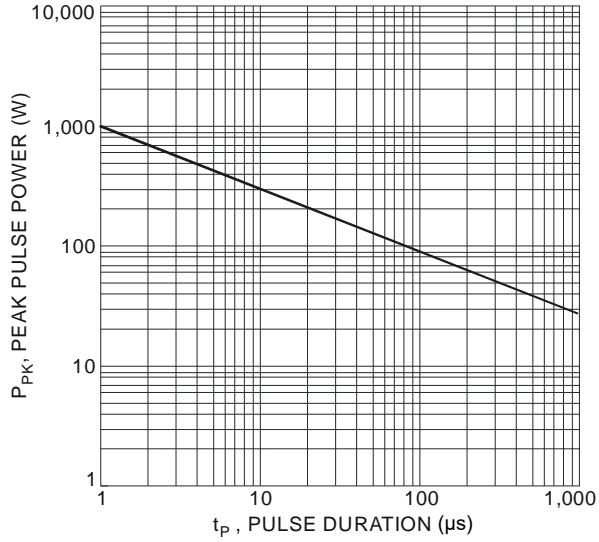
Characteristic	Symbol	Value	Unit
Package Power Dissipation (Note 5)	P _D	300	mW
Thermal Resistance, Junction to Ambient (Note 5)	R _{θJA}	417	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-55 to +150	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Typ	Max	Unit	Test Conditions
Reverse Standoff Voltage	V _{RWM}	—	—	24	V	—
Channel Leakage Current (Note 6)	I _{RM}	—	<1	50	nA	V _{RWM} = 24V
Clamping Voltage, Positive Transients	V _{CL}	—	—	40	V	I _{PP} = 1A, t _P = 8/20μs, Figure 1
		—	—	70		I _{PP} = 3A, t _P = 8/20μs, Figure 1
Breakdown Voltage	V _{BR}	25.4	27.8	30.3	V	I _R = 1mA
Channel Input Capacitance	C _T	—	11	17	pF	V _R = 0V, f = 1MHz
		—	9	15		
ABS Parasitic Capacitance Matching (Channel 1 – Channel 2)	Δ (C _{T_Ch1} - C _{T_Ch2}) / C _{T_Max}	—	0.13	1.5	%	V _R = 5V, f = 250kHz
	Δ (C _{T_Ch1} - C _{T_Ch2})	—	0.02	0.22	pF	

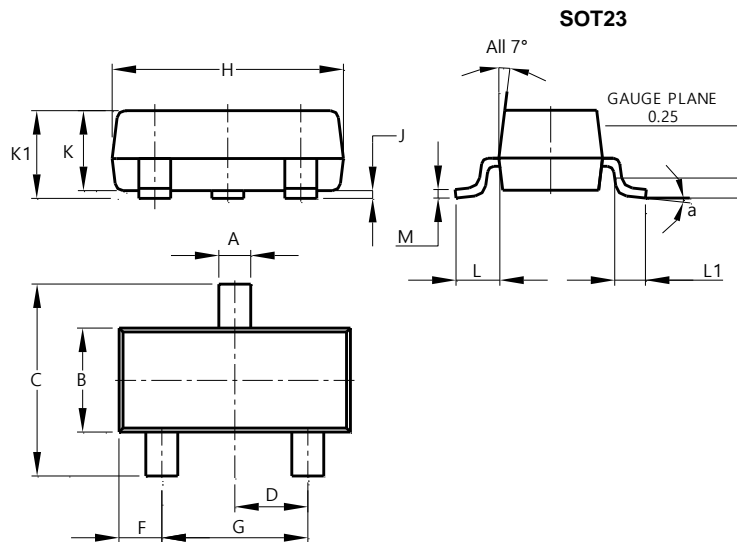
- Notes:
- Device mounted on FR-4 PCB pad layout (2oz copper) as shown on Diodes Incorporated suggested pad layout, which can be found on our website at <http://www.diodes.com/package-outlines.html> for the latest version.
 - Short duration pulse test used to minimize self-heating effect.





Package Outline Dimensions

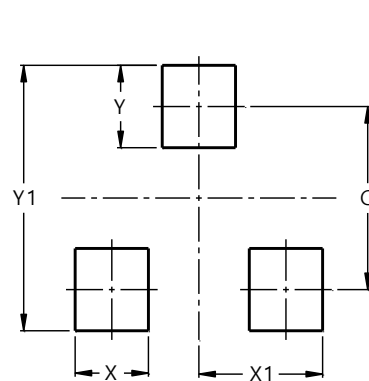
Please see <http://www.diodes.com/package-outlines.html> for the latest version.



SOT23			
Dim	Min	Max	Typ
A	0.37	0.51	0.40
B	1.20	1.40	1.30
C	2.30	2.50	2.40
D	0.89	1.03	0.915
F	0.45	0.60	0.535
G	1.78	2.05	1.83
H	2.80	3.00	2.90
J	0.013	0.10	0.05
K	0.890	1.00	0.975
K1	0.903	1.10	1.025
L	0.45	0.61	0.55
L1	0.25	0.55	0.40
M	0.085	0.150	0.110
a	0°	8°	--
All Dimensions in mm			

Suggested Pad Layout

Please see <http://www.diodes.com/package-outlines.html> for the latest version.



Dimensions	Value (in mm)
C	2.0
X	0.8
X1	1.35
Y	0.9
Y1	2.9

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